

Vishay Siliconix

P-Channel 1.8 V (G-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|--|--------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) | | |
| - 12 | 0.165 at V _{GS} = - 4.5 V | - 0.95 | | |
| | 0.220 at V _{GS} = - 2.5 V | - 0.82 | | |
| | 0.280 at V _{GS} = - 1.8 V | - 0.67 | | |

D 1 6 D D 2 5 D G 3 4 S Top View

SC-89 (6-LEADS)

Ordering Information: Si1039X-T1-GE3 (Lead (Pb)-free and Halogen-free)

Marking Code

WL

Lot Traceability

and Date Code

Part Number Code

0

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Low Threshold
- Smallest LITTLE FOOT[®] Package: 1.6 mm x 1.6 mm
- Low 0.6 mm Profile
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Cell Phones and Pagers
 Load Switch

| ABSOLUTE MAXIMUM RATINGS (T | _A = 25 °C, unle | ess otherwise | noted) | | |
|---|----------------------------|-----------------------------------|-------------|--------------|------|
| Parameter | | Symbol | 5 s | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | - 12 | | V |
| Gate-Source Voltage | | V _{GS} | ± 8 | | v |
| Continuous Drain Current /T - 150 °C)a | T _A = 25 °C | – I _D | - 0.95 | - 0.87 | А |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 70 °C | | - 0.76 | - 0.69 | |
| Pulsed Drain Current | | I _{DM} | - 4 | | A |
| Continuous Diode Current (Diode Conduction) ^a | | ۱ _S | - 0.18 | - 0.14 | |
| Maximum Power Dissipation ^a | T _A = 25 °C | – P _D | 0.21 | 0.17 | w |
| | T _A = 70 °C | | 0.13 | 0.10 | ٧V |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | °C |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|---------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum hunsting to Auchieuta | $t \le 5 s$ | - R _{thJA} | 500 | 600 | °C/W | |
| Maximum Junction-to-Ambient ^a | Steady State | | 600 | 720 | 0/11 | |

Notes:

a. Surface mounted on 1" x 1" FR4 board with minimum copper.

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| Parameter | Symbol | Test Conditions Min. | | Тур. | Max. | Unit | |
|---|---------------------|---|--------|--------|-------|------|--|
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.45 | | | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 8 V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -12 V, V_{GS} = 0 V$ | | - 1 | | ۸ | |
| | | V_{DS} = - 12 V, V_{GS} = 0 V, T_{J} = 70 °C | - | | | - μΑ | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 4.5 V | - 4 | | | А | |
| Drain-Source On-State Resistance ^a | | V _{GS} = - 4.5 V, I _D = - 0.87 A | | 0.140 | 0.165 | Ω | |
| | R _{DS(on)} | V _{GS} = - 2.5 V, I _D = - 0.75 A | | 0.180 | 0.220 | | |
| | | V _{GS} = - 1.8 V, I _D = - 0.2 A | | 0.230 | 0.280 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 0.87 A | | 3.5 | | S | |
| Diode Forward Voltage ^a | V _{SD} | I _S = - 0.14 A, V _{GS} = 0 V | | - 0.78 | - 1.2 | V | |
| Dynamic ^b | | | • | | | | |
| Total Gate Charge | Qg | | | 3.8 | 6 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 6 V, V_{GS} = - 4.5 V, I_D = - 0.87 A | | 0.7 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 0.8 | | | |
| Turn-On Delay Time | t _{d(on)} | | | 15 | 30 | | |
| Rise Time | t _r | V_{DD} = - 6 V, R_L = 12 Ω | | 20 | 40 | ns | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ - 0.5 A, V_GEN = - 4.5 V, R_g = 6 Ω | | 30 | 60 | | |
| Fall Time | t _f | | | 16 | 30 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = - 0.14 A, dl/dt = 100 A/μs | | 20 | 40 | | |

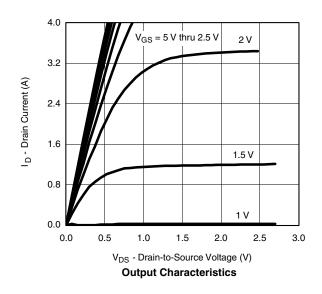
Notes:

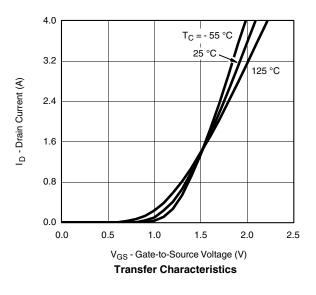
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Si1039X Vishay Siliconix

10

8

75

3

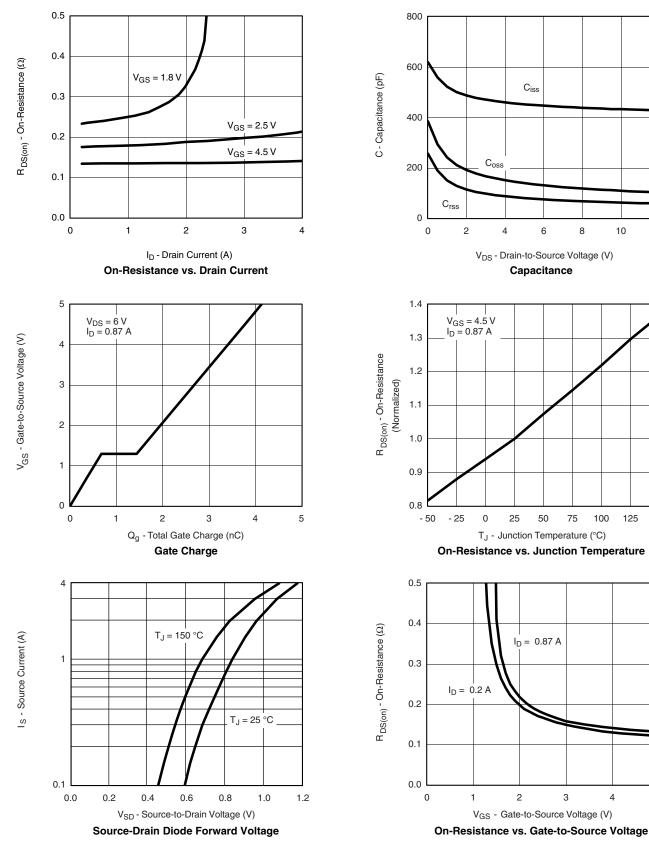
100

125

150

12

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



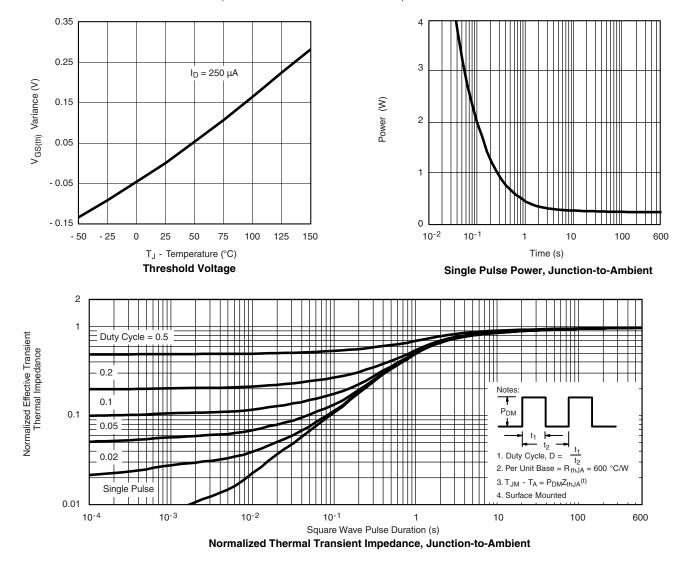
Document Number: 70682 S10-2544-Rev. D, 08-Nov-10 5

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?70682.



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